



SOT1408-1

plastic, super thin quad flat package; no leads; 12 terminals;
body 2.10 x 1.25 x 0.35 mm

8 February 2016

Package information

1. Package summary

Terminal position code	D (double)
Package type descriptive code	SOT1408
Package type industry code	X2QFN12
Package style descriptive code	QFP (quad flat package)
Package style suffix code	NA (not applicable)
Package body material type	P (plastic)
JEDEC package outline code	MO-255
Mounting method type	S (surface mount)
Issue date	19-1-2015

Table 1. Package summary

Symbol	Parameter	Min	Typ	Nom	Max	Unit
D	package length	2.05	-	2.1	2.15	mm
E	package width	1.2	-	1.25	1.3	mm
A	seated height	0.3	-	0.35	0.4	mm
e	nominal pitch	-	-	0.4	-	mm
n ₂	actual quantity of termination	-	-	12	-	



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2. Package outline

X2QFN12: plastic, super thin quad flat package; no leads; 12 terminals; body 2.10 x 1.25 x 0.35 mm SOT1408-1

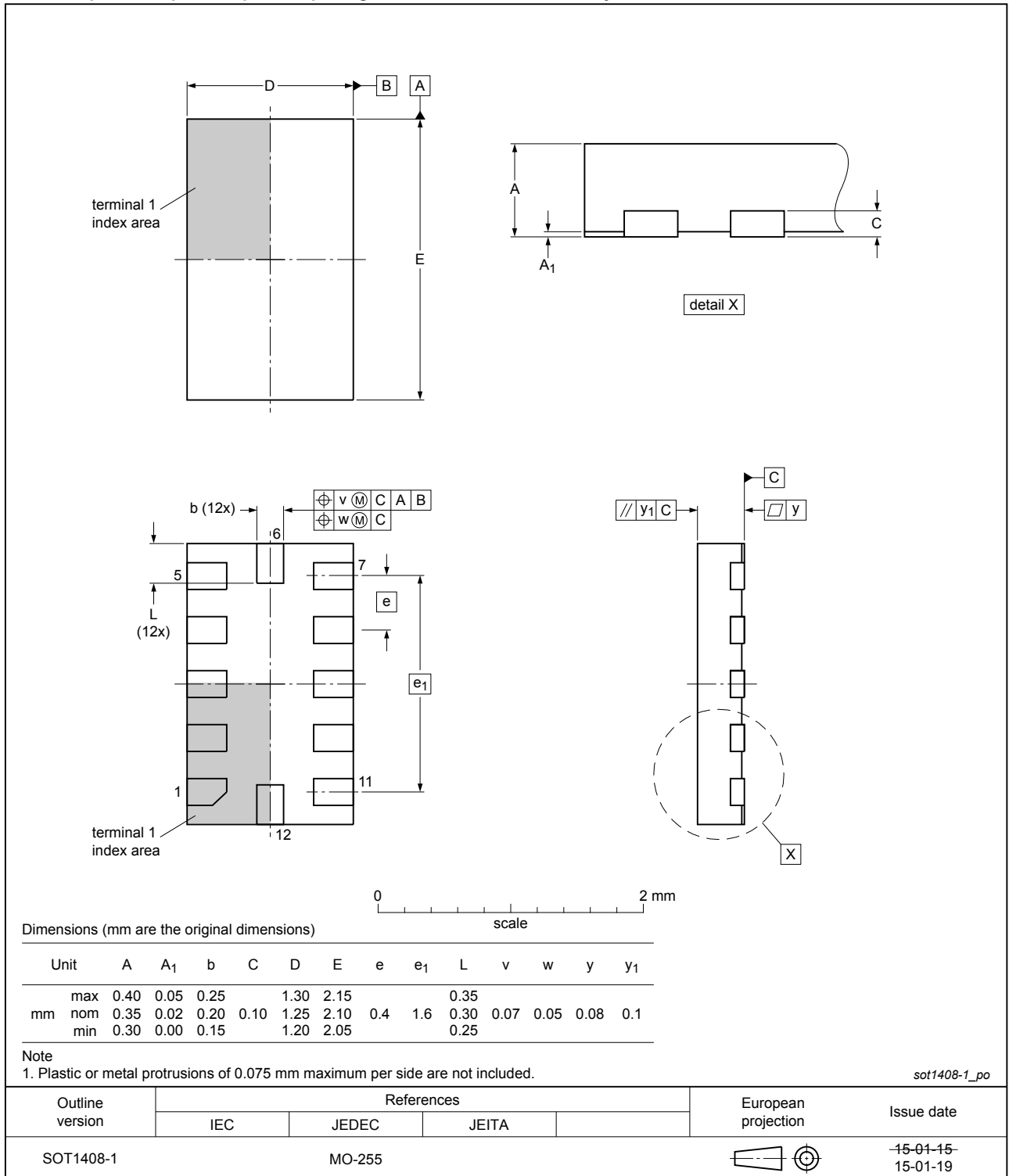


Fig. 1. Package outline X2QFN12 (SOT1408-1)

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3. Legal information

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